Board to Board Connectors Z-STACK Connectors Type F8

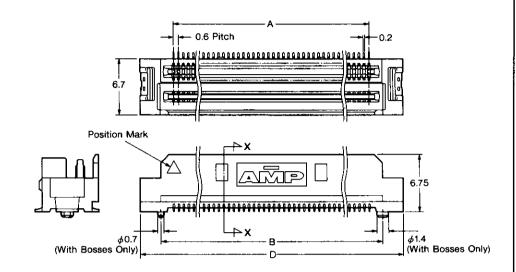
Material and Finish:

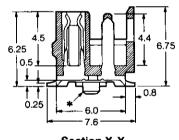
Housing—Liquid crystal polymer Contacts—0.5µm min. thick gold over 1.3µm min. thick nickel in contact area and 1.0µm min. thick tin-lead or tin over 1.3µm min. thick nickel in soldering area.

Stacking height 8mm; F8 + F8

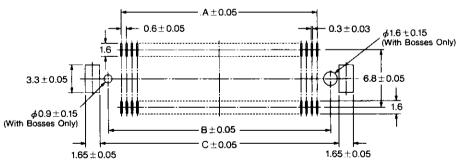
Stacking height 12mm;

F8 + F16









PC Board Layout

| Туре | No. of Pos. | Dimensions | | | | Dark No. * |
|------|----------------|------------|------|------|--------|------------|
| | | Α | В | С | D | Part No.* |
| F8 | 80 | 23.4 | 26.6 | 28.5 | 31.4 – | 353094-1 |
| | | | | | | 353094-2 |
| | 240 | 71.4 | 74.6 | 76.5 | 79.4 – | 316918-1 |
| | | | | | | 316918-2 |

^{*}Part Numbers with suffix number - 1 are with bosses, and those with - 2 are without bosses.